

COINS 2020

IEEE International Conference on Omni-layer Intelligent systems

July 27-29, 2020
Barcelona, Spain
<https://coinsconf.com>




Call for Papers

COINS is the premier conference devoted to omni-layer techniques for smart IoT systems, by identifying new perspectives and highlighting impending research issues and challenges. Topics of interest include, but are not limited to, the following:

- Internet of Things: From Device, to Edge, and Cloud
- Omni-Layer Security, Privacy, and Trust
- VLSI, Sensors, Embedded Systems, and Computer Architecture
- Real-time Systems
- Alternative and Approximate Computing
- Cloud Computing
- Big Data
- Artificial Intelligence, Machine Learning, Cognitive Computing, and Advanced Analytics
- Intelligent IoT eHealth

Key Dates

 **March 06** Submission of Regular Papers and Special Session Papers
March 06, 2020

 **Dec. 14** Submission of Special Sessions proposal
Dec. 14, 2019

 **May 06** Notification of Paper Acceptance
May 06, 2020

 **Nov. 23** Notification of Proposal Acceptance
De 06, 2020

 **May 16** Camera-Ready Submission
May 16, 2020



Organizing Committee

Conference Board

Krishnendu Chakrabarty, Duke University, USA
Jan M. Rabaey, UC Berkeley, USA
David Z. Pan, University of Texas at Austin, USA
Majid Sarrafzadeh, UCLA, USA
Farshad Firouzi, Duke University, USA

General Chairs

Farshad Firouzi, Duke University, USA
Krishnendu Chakrabarty, Duke University, USA

Technical Chairs

William Fornaciari, Politecnico di Milano, Italy Vasilis Pavlidis (IEEE CEDA), University of Manchester, UK
Bahar Farahani, CRC, Germany

Local Chairs

Jose Ayala, University of Madrid, Spain Marina Zapater Sancho, EPFL, Switzerland

Track Chairs

JOsé Manuel Benitez, University of Granada, Spain
Sebastian Ventura, University of Córdoba, Spain
Jiang Li, Shanghai Jiaotong University, China
Davide Brunelli, University of Trento, Italy
Maria K. Michael, University of Cyprus, Cyprus
Amir Rahmani, University of California Irvine, USA
Federica Cena, Università di Torino, Italy
Kun-Chih Chen (Jimmy), National Sun Yat-Sen University, Taiwan
Chung-Wei Lin, National Taiwan University, Taiwan
Xing Liu, Kwantlen Polytechnic University, Canada
Kim Grütner, OFFIS, Germany
Wanli Chang, University of York, UK